

TL7700-SEP Single-Event Latch-Up (SEL)

ABSTRACT

The purpose of this study was to characterize the effects of heavy-ion irradiation on the single-event latchup (SEL) performance of the TL7700-SEP supply-voltage supervisor. Heavy-ions with an LET_{EFF} of 43 MeV-cm²/mg were used to irradiate the devices with a fluence of 1 × 10⁷ ions/cm². The results demonstrate that the TL7700-SEP is SEL-free up to LET_{EFF} = 43 MeV-cm²/mg at 125°C.

Contents

| | | ew | |
|-------|----------|----------------------------------|----|
| | | lechanisms | |
| | | evice and Test Board Information | |
| 4 | Irradiat | tion Facility and Setup | 6 |
| 5 | Results | 5 | 7 |
| 6 | Summa | ary | 8 |
| Appen | dix A | Confidence Interval Calculations | 9 |
| Appen | dix B | Confidence Interval Calculations | 11 |

List of Figures

| 1 | Functional Block Diagram of the TL7700-SEP | 3 |
|---|---|---|
| 2 | TL7700-SEP Pinout Diagram | 4 |
| 3 | TL7700-SEP Bias Board Used for SEL Testing | 4 |
| 4 | TL7700-SEP Bias Diagram | 5 |
| 5 | Current vs Time (I vs t) Data for V _s Current During SEL Run #44 | 7 |
| | | |

List of Tables

| 1 | Overview Information | 2 |
|---|---|----|
| 2 | TL7700-SEP SEL Conditions Using ⁴⁷ Ag at an Angle-of-Incidence of 0° | 7 |
| 3 | Experimental Example Calculation of MFTF and σ Using a 95% Confidence Interval | 10 |

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1 Overview

The TL7700-SEP is a bipolar integrated circuit designed for use as a reset controller in microcomputer and microprocessor systems. The SENSE voltage can be set to any value greater than 0.5 V using two external resistors. Circuit function is very stable with supply voltage in the 1.8-V to 40-V range. Minimum supply current allows use with ac line operation, portable battery operation, and automotive applications. The TL7700-SEP device is designed for operation from –55°C to 125°C.

www.ti.com/product/TL7700-SEP/technicaldocuments

| Table 1. Overview Information ⁽¹⁾ | Table | 1. Overview | Information ⁽¹⁾ |
|--|-------|-------------|----------------------------|
|--|-------|-------------|----------------------------|

| DESCRIPTION | DEVICE INFORMATION |
|---------------------------|---|
| TI Part Number | TL7700-SEP |
| VID Number | V62/19602 |
| Device Function | Radiation hardened supply-voltage supervisor in space enhanced plastic |
| Technology | JI1 |
| Exposure Facility | Radiation Effects Facility, Cyclotron Institute, Texas A&M University |
| Heavy Ion Fluence per Run | $1 \times 10^{6} - 1 \times 10^{7}$ ions/cm ² |
| Irradiation Temperature | 125°C (for SEL testing) |

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2 SEE Mechanisms

The primary single-event effect (SEE) events of interest in the TL7700-SEP are single-event latch-up (SEL). From a risk/impact point-of-view, the occurrence of an SEL is potentially the most destructive SEE event and the biggest concern for space applications. The JI1 was used for the TL7700-SEP. CMOS circuitry introduces a potential for SEL and SEB susceptibility. SEL can occur if excess current injection caused by the passage of an energetic ion is high enough to trigger the formation of a parasitic cross-coupled PNP and NPN bipolar structure (formed between the p-sub and n-well and n+ and p+ contacts). The parasitic bipolar structure initiated by a single-event creates a high-conductance path (inducing a steady-state current that is typically orders-of-magnitude higher than the normal operating current) between power and ground that persists (is "latched") until power is removed or until the device is destroyed by the high-current state. The process modifications applied for SEL-mitigation were sufficient as the TL7700-SEP exhibited no SEL with heavy-ions up to an LET_{EFF} of 43 MeV-cm²/mg at a fluence of 10^7 ions/cm² and a chip temperature of 125°C.

This study was performed to evaluate the SEL effects with a bias voltage of 40 V on V_s supply voltage. Heavy ions with $LET_{EFF} = 43 \text{ MeV-cm}^2/\text{mg}$ were used to irradiate the devices. Flux of 10^5 ions/s-cm² and fluence of 10^7 ions/cm² were used during the exposure at 125° C temperature.

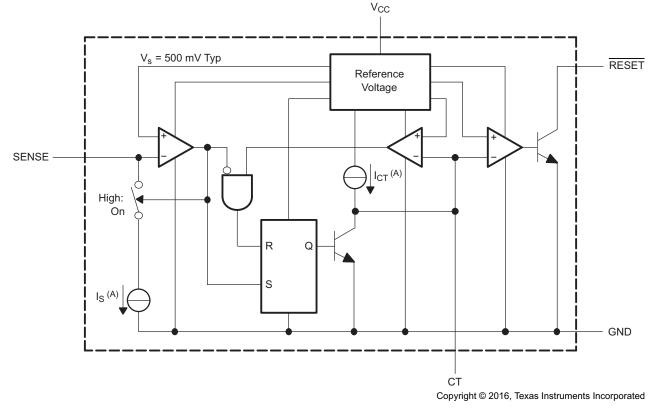


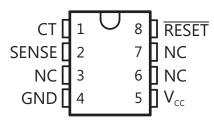
Figure 1. Functional Block Diagram of the TL7700-SEP



Test Device and Test Board Information

3 Test Device and Test Board Information

The TL7700-SEP is packaged in a 8-pin, TSSOP shown with pinout in Figure 2. The TL7700-SEP bias board used for the SEE characterization is shown in Figure 3 and bias diagram in Figure 4.



NC – No internal connection

NOTE: The package was decap'ed to reveal the die face for all heavy ion testing.



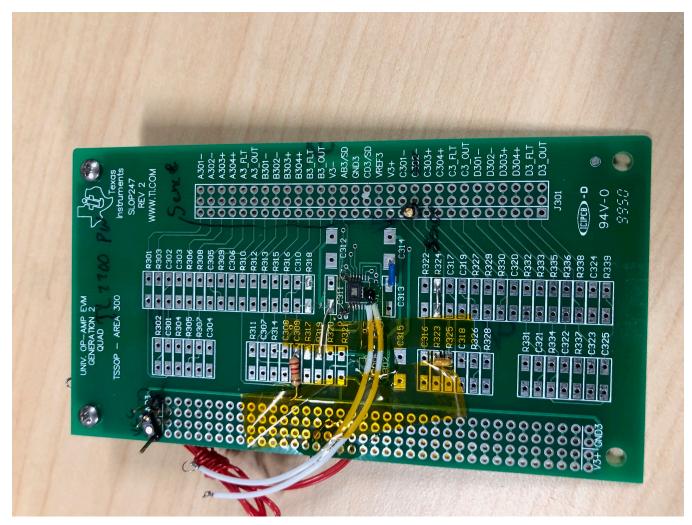


Figure 3. TL7700-SEP Bias Board Used for SEL Testing





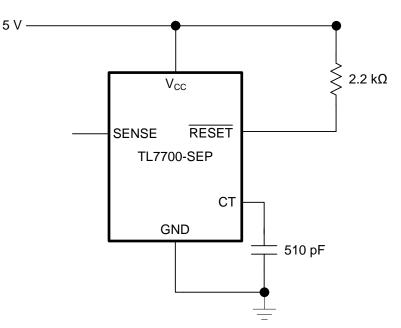


Figure 4. TL7700-SEP Bias Diagram



4 Irradiation Facility and Setup

The heavy ion species used for the SEE studies on this product were provided and delivered by the TAMU Cyclotron Radiation Effects Facility [3] using a superconducting cyclotron and advanced electron cyclotron resonance (ECR) ion source. Ion beams are delivered with high uniformity over a 1-in diameter circular cross sectional area for the in-air station. Uniformity is achieved by means of magnetic defocusing. The intensity of the beam is regulated over a broad range spanning several orders of magnitude. For the bulk of these studies, ion fluxes between 10⁴ and 10⁵ ions/s-cm² were used to provide heavy ion fluences between 10⁶ and 10⁷ ions/cm². For these experiments silver (Ag) ions were used. Ion beam uniformity for all tests was in the range of 91% to 98%.

5 Results

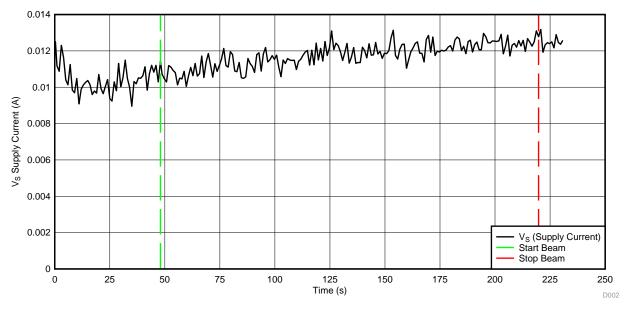
5.1 SEL Results

During SEL characterization, the device was heated using forced hot air, maintaining the IC temperature at 125°C. The temperature was monitored by means of a K-type thermocouple attached as close as possible to the IC. The species used for the SEL testing was a silver (⁴⁷Ag) ion with an angle-of-incidence of 0° for an LET_{EFF} = 43 MeV-cm²/mg. The kinetic energy in the vacuum for this ion is 1.634 GeV (15-MeV/amu line). A flux of approximately 10^5 ions/cm²-s and a fluence of approximately 10^7 ions were used for three runs. The V_s supply voltage is supplied externally on board at recommended maximum voltage setting of 40 V and the Vsense is set at 0.503 V. Run duration to achieve this fluence was approximately 2 minutes. No SEL events were observed during all four runs shown in Table 2. Figure 5 shows a plot of the current vs time.

| | Table 2. TL7700-SEP SE | L Conditions Us | sing ⁴⁷ Ag at an . | Angle-of-Incidence of 0° |
|--|------------------------|-----------------|-------------------------------|--------------------------|
|--|------------------------|-----------------|-------------------------------|--------------------------|

| RUN # | DISTANCE (mm) | TEMPERATURE (°C) | ION | ANGLE | FLUX (ions₊cm²/mg) | FLUENCE (# ions) | LET _{EFF} (MeV.cm²/mg) |
|-------|------------------|---------------------|-----|-------|-----------------------|---------------------|------------------------------------|
| 44 | 40 | 125 | Ag | 0° | 1.00E+05 | 1.00E+07 | 43 |

No SEL events were observed, indicating that the TL7700-SEP is SEL-immune at $LET_{EFF} = 43 \text{ MeV-} \text{cm}^2/\text{mg}$ and T = 125°C. Using the MFTF method described in Appendix A and combining (or summing) the fluences of the two runs @ 125°C (1 × 10⁷), the upper-bound cross-section (using a 95% confidence level) is calculated as:



 σ SEL $\leq 3.69 \times 10^{-7}$ cm² for LET_{EFF} = 43 MeV-cm²/mg and T = 125°C.

Figure 5. Current vs Time (I vs t) Data for V_s Current During SEL Run #44



Summary

6 Summary

Radiation effects of TL7700-SEP radiation hardened supply-voltage supervisor in space enhanced plastic was studied. This device passed total dose rate of up to 20 krad(Si) and is latch-up immune up to LET_{EFF} = 43 MeV-cm²/mg and T = 125°C.



Confidence Interval Calculations

For conventional products where hundreds of failures are seen during a single exposure, one can determine the average failure rate of parts being tested in a heavy-ion beam as a function of fluence with high degree of certainty and reasonably tight standard deviation, and thus have a good deal of confidence that the calculated cross-section is accurate.

With radiation hardened parts however, determining the cross-section becomes more difficult since often few, or even, no failures are observed during an entire exposure. Determining the cross-section using an average failure rate with standard deviation is no longer a viable option, and the common practice of assuming a single error occurred at the conclusion of a null-result can end up in a greatly underestimated cross-section.

In cases where observed failures are rare or non-existent, the use of confidence intervals and the chisquared distribution is indicated. The Chi-Squared distribution is particularly well-suited for the determination of a reliability level when the failures occur at a constant rate. In the case of SEE testing, where the ion events are random in time and position within the irradiation area, one expects a failure rate that is independent of time (presuming that parametric shifts induced by the total ionizing dose do not affect the failure rate), and thus the use of chi-squared statistical techniques is valid (since events are rare an exponential or Poisson distribution is usually used).

In a typical SEE experiment, the device-under-test (DUT) is exposed to a known, fixed fluence (ions/cm²) while the DUT is monitored for failures. This is analogous to fixed-time reliability testing and, more specifically, time-terminated testing, where the reliability test is terminated after a fixed amount of time whether or not a failure has occurred (in the case of SEE tests fluence is substituted for time and hence it is a fixed fluence test [5]). Calculating a confidence interval specifically provides a range of values which is likely to contain the parameter of interest (the actual number of failures/fluence). Confidence intervals are constructed at a specific confidence level. For example, a 95% confidence level implies that if a given number of units were sampled numerous times and a confidence interval estimated for each test, the resulting set of confidence intervals would bracket the true population parameter in about 95% of the cases.

In order to estimate the cross-section from a null-result (no fails observed for a given fluence) with a confidence interval, we start with the standard reliability determination of lower-bound (minimum) mean-time-to-failure for fixed-time testing (an exponential distribution is assumed):

$$MTTF = \frac{2nT}{\chi^2_{2(d+1);100(1-\frac{a}{2})}}$$
(1)

Where *MTTF* is the minimum (lower-bound) mean-time-to-failure, *n* is the number of units tested (presuming each unit is tested under identical conditions) and *T*, is the test time, and χ^2 is the chi-square distribution evaluated at 100(1 – α / 2) confidence level and where *d* is the degrees-of-freedom (the number of failures observed). With slight modification for our purposes we invert the inequality and substitute *F* (fluence) in the place of *T*:

$$MFTF = \frac{2nF}{\chi^{2}_{2(d+1);\ 100(1-\frac{\alpha}{2})}}$$
(2)

Where now *MFTF* is mean-fluence-to-failure and *F* is the test fluence, and as before, χ^2 is the chi-square distribution evaluated at 100(1 – α / 2) confidence and where *d* is the degrees-of-freedom (the number of failures observed). The inverse relation between *MTTF* and failure rate is mirrored with the *MFTF*. Thus the upper-bound cross-section is obtained by inverting the *MFTF*:

$$\sigma = rac{\chi^2_{2(d+1);100(1-rac{a}{2})}}{2nF}$$

(3)

q



Assume that all tests are terminated at a total fluence of 10^6 ions/cm². Also assume there are a number of devices with very different performances that are tested under identical conditions. Assume a 95% confidence level ($\sigma = 0.05$). Note that as *d* increases from 0 events to 100 events the actual confidence interval becomes smaller, indicating that the range of values of the true value of the population parameter (in this case the cross-section) is approaching the mean value + 1 standard deviation. This makes sense when one considers that as more events are observed the statistics are improved such that uncertainty in the actual device performance is reduced.

| Degrees-of-Freedom | | χ ² @ 95% | Calculated Cross Section (cm ²) | | | |
|--------------------|----------|----------------------|---|----------|---------------------------------|--|
| (d) | 2(d + 1) | | Upper-Bound @ 95% Confidence | Mean | Average + Standard Deviation | |
| 0 | 2 | 7.38 | 3.69E-06 | 0.00E+00 | 0.00E+00 | |
| 1 | 4 | 11.14 | 5.57E-06 | 1.00E-06 | 2.00E-06 | |
| 2 | 6 | 14.45 | 7.22E-06 | 2.00E-06 | 3.41E-06 | |
| 3 | 8 | 17.53 | 8.77E-06 | 3.00E-06 | 4.73E-06 | |
| 4 | 10 | 20.48 | 1.02E–05 | 4.00E-06 | 6.00E-06 | |
| 5 | 12 | 23.34 | 1.17E–05 | 5.00E-06 | 7.24E–06 | |
| 10 | 22 | 36.78 | 1.84E–05 | 1.00E-05 | 1.32E-05 | |
| 50 | 102 | 131.84 | 6.59E05 | 5.00E-05 | 5.71E-05 | |
| 100 | 202 | 243.25 | 1.22E–04 | 1.00E-04 | 1.10E–04 | |

Table 3. Experimental Example Calculation of MFTF and σ Using a 95% Confidence Interval⁽¹⁾

⁽¹⁾ Using a 95% confidence interval for several different observed results (d = 0, 1, 2,...100 observed events during fixed-fluence tests) assuming 10⁶ ions/cm² for each test. Note that as the number of observed events increases the confidence interval approaches the mean.



Appendix B SLVK043–April 2019

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